



\*. R101 is a reworked part.

# Built on PMP10276RevB PCB

PCB Number: PMP10468  
PCB Rev: B

PCB  
LOGO  
Texas Instruments

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Designed for: Public Release	Mod. Date: 3/3/2015	
Project Title: Universal AC to 24V/25W using UCC28700	Sheet Title:	
Number: PMP10468   Rev: A	Assembly Variant: 001	
SVN Rev. Version control disabled	Sheet: 1 of 1	
Drawn By: S Yu	File: PMP10468_01_SchDoc	Size: B
Engineer: S Yu	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	7 Texas Instruments 2014

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